

Amkor Technology, Inc. Corporate Update

External | Q3 2022

Amkor by the Numbers











11,000,000
Square Feet of
Manufacturing Space



Footprint in 11 countries

End Markets







Automotive

Communications

Industrial





Computing

Consumer

*2021 results



Q3 2022 Results

- Record Q3 revenue of \$2.1B, up 24% YoY
- Full recovery in Shanghai operations
- Record revenue in all end markets
- Steep ramps in support of Fall launch of premium tier smartphones and new IoT and automotive products





Q3 2022 End Markets



Communications

- Revenue up 35% YoY
- Strength in 5G premium tier smartphones
- Wide range of Advanced packaging technology offerings



Consumer

- Revenue up 14% YoY
- New IoT product ramps
- Expanding in Vietnam to support future demand



Automotive and Industrial

- Revenue up 13% YoY
- Trusted partner of leading automotive customers
- Expanding capacity and technology in key regions



Computing

- Revenue up 22% YoY
- Deverticalization with new players emerging
- Increasing outsourced supply chains

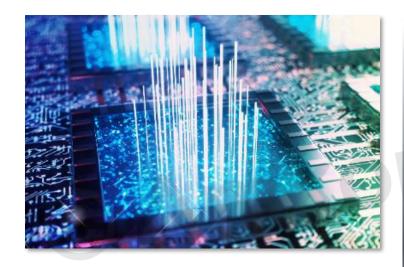
Q4 2022 Outlook

- Quarterly revenue of \$1.85BUp 7% YoY
- Pockets of softening & inventory buildup in PCs and mid/low tier smartphones
- Resilient demand for advanced packaging within premium tier smartphones and automotive electronics
- ▶ U.S. export controls impact low single digits percent of revenue





Amkor's Differentiators



Technology

- Advanced Packaging Leadership
- Engineering Services
- ▶ Broad Portfolio



Operational Excellence

- QualityFIRST Culture
- Execution
- ► Continuous Improvement



Service

- Design Through Drop Ship
- Manufacturing Footprint
- Local Sales & Support



Best-In-Class R&D

Staying ahead of the semiconductor technology curve



550+

R&D Engineers







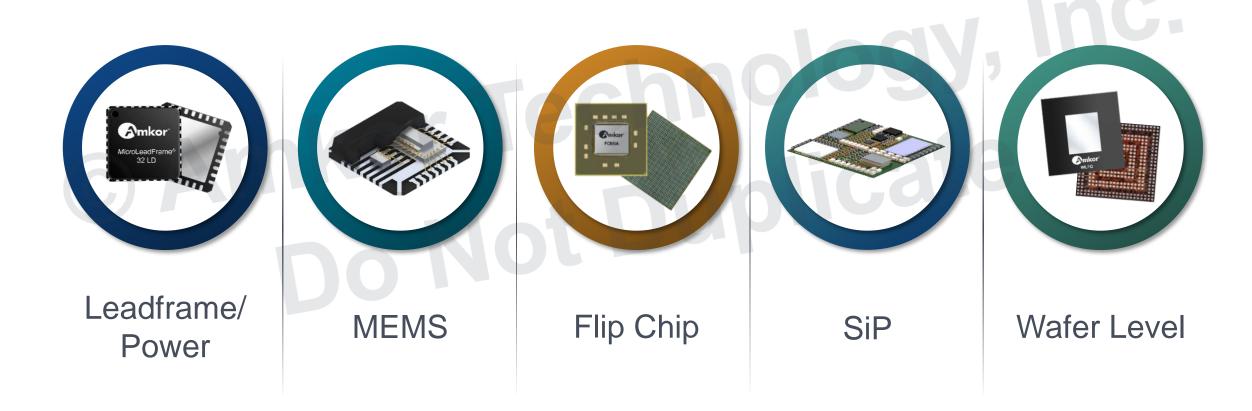


Strong Partnerships with Customers



Complete Package and Test Portfolio

Turnkey services from wafer sort through drop ship





Quality Across the Organization





Broad Geographic Footprint

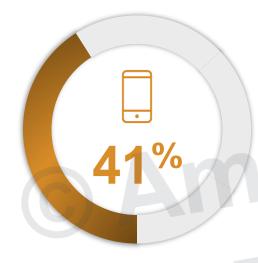
11 million square feet of manufacturing space





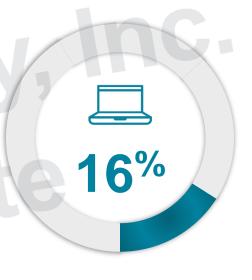
End Market Distribution

2021 % of Revenue









Communications

Smartphones Tablets

Consumer

A/R & Gaming Connected Home Home Electronics Wearables

Automotive & Industrial

ADAS
Electrification
Infotainment
Safety

Computing

Data Center
HPC
Infrastructure
Storage



Amkor Throughout the Smartphone

Communications

Value Propositions

- Recognized technology leader
- Diverse packaging solutions
- Large scale manufacturing in multiple geographies





Amkor Makes IoT Possible

Consumer

Multiple Applications



Connectivity
Sensing
Computing
Storage

Diverse Requirements



Power
Bandwidth
Integration
Security

Scale



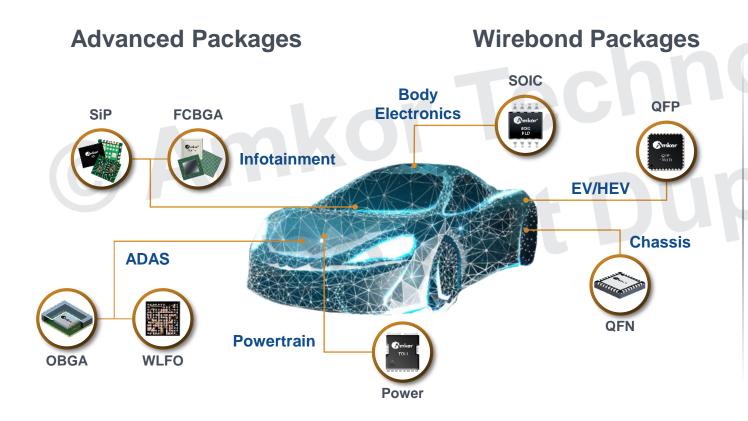
Amkor ships billions of IoT devices per year!





Amkor Enabling New Applications in the Car

Largest Automotive OSAT



Value Propositions

- >40 yrs of Automotive experience
- QualityFIRST mindset
- Leader in advanced automotive packaging



Amkor Supports All Big Data Requirements

Computing



Data Center

HPC, AI, ML Performance FCBGA, HDFO, SiP



Networking

Switch, SerDes Integration SiP, HDFO, 2.5D



Storage

Solid state drive
Die stacking
Stack CSP, WBBGA, SiP



Our Priorities



Customer Satisfaction

Quality Service Technology



Company Culture

Collaborative Innovative Fast-paced



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Thank You

